



DMG4468LFG N-CHANNEL ENHANCEMENT MODE MOSFET

Features

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Lead Free By Design/RoHS Compliant (Note 1)
- "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: DFN3030-8 •
- Case Material: Molded Plastic, "Green" Molding Compound. • UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Marking Information: See Page 5
- Ordering Information: See Page 5
- Weight: 0.0172 grams (approximate)

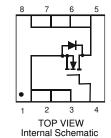
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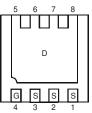




TOP VIEW

BOTTOM VIEW





BOTTOM VIEW Pin Configuration

Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V _{DSS}	30	V
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Drain Current (Note 3)	Steady State	T _A = 25°C T _A = 85°C	ID	7.62 4.83	А
Pulsed Drain Current (Note 4)			I _{DM}	45.9	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 3)	PD	0.99	W
Thermal Resistance, Junction to Ambient @TA = 25°C (Note 3)	R _{0JA}	126.7	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

Notes:

No purposefully added lead.
Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
Device mounted on FR-4 PCB, with minimum recommended pad layout.

4. Repetitive rating, pulse width limited by junction temperature.

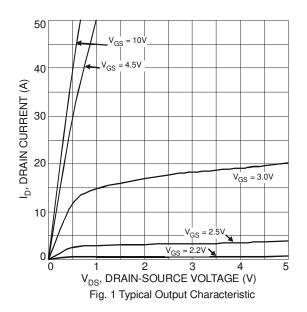


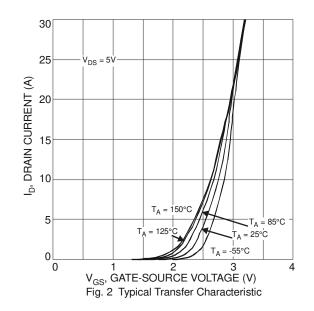
Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	T. m	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 5)	Symbol	IVIIII	Тур	wax	Unit	Test condition	
Drain-Source Breakdown Voltage	BV _{DSS}	30	-	-	V	$V_{GS} = 0V, I_{D} = 250 \mu A$	
Zero Gate Voltage Drain Current $T_J = 25^{\circ}C$	I _{DSS}	-	-	1.0	μA	$V_{DS} = 30V, V_{GS} = 0V$	
Gate-Source Leakage	IGSS	-	-	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 5)	-					•	
Gate Threshold Voltage	V _{GS(th)}	1.0	-	2.0	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance		-	10	15	mΩ	$V_{GS} = 10V, I_D = 11.6A$	
Static Drain-Source On-Resistance	R _{DS (ON)}		17	23.5		$V_{GS} = 4.5V, I_D = 10A$	
Forward Transfer Admittance	Y _{fs}	-	8	-	S	$V_{DS} = 10V, I_{D} = 9A$	
Diode Forward Voltage	V _{SD}	-	0.7	1.0	V	$V_{GS} = 0V, I_S = 1A$	
DYNAMIC CHARACTERISTICS (Note 6)							
Input Capacitance	Ciss	-	867	-	рF	V _{DS} = 10V, V _{GS} = 0V, f = 1.0MHz	
Output Capacitance	Coss	-	85	-	pF		
Reverse Transfer Capacitance	C _{rss}	-	81	-	pF		
Gate Resistance	Rg	-	1.39	-	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge	Qg	-	18.85	-	nC	V _{GS} = 10V, V _{DS} = 15V, I _D = 11.6A	
Gate-Source Charge	Q _{gs}	-	2.59	-	nC		
Gate-Drain Charge	Q _{gd}	-	6.15	-	nC		
Turn-On Delay Time	t _{D(on)}	-	5.46	-	ns		
Turn-On Rise Time	tr	-	14.53	-	ns		
Turn-Off Delay Time	t _{D(off)}	-	18.84	-	ns		
Turn-Off Fall Time	t _f	-	6.01	-	ns		

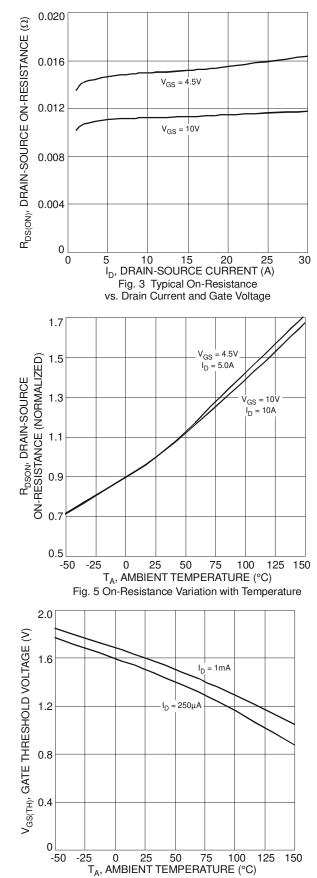
Notes:

Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to production testing.

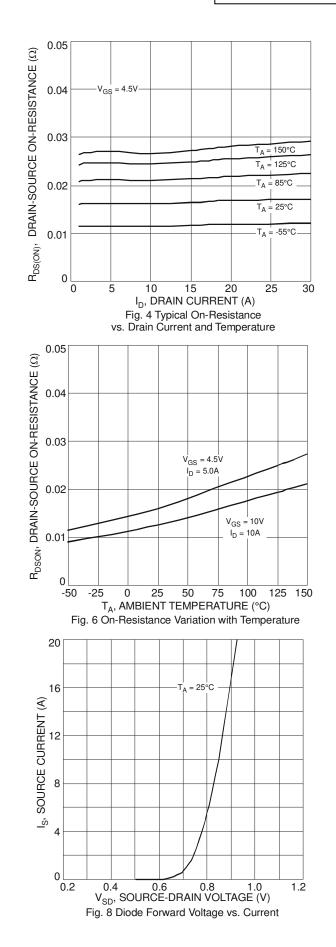






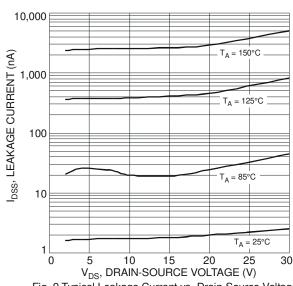


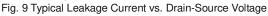


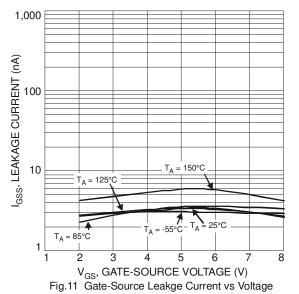


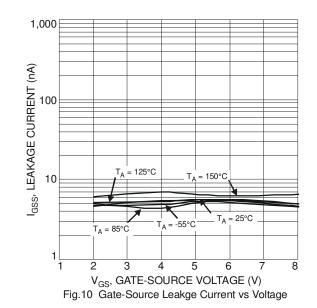


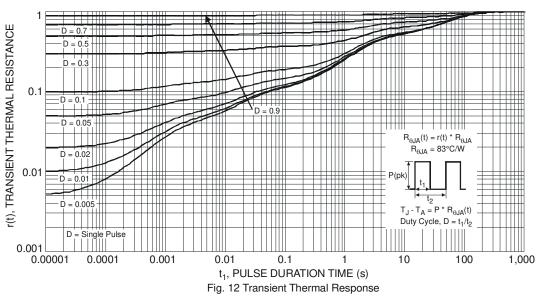
NEW PRODUCT









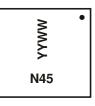




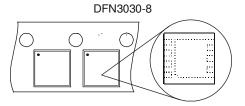
Ordering Information (Note 7)					
Part Number	Case	Packaging			
DMG4468LFG-7	DFN3030-8	3000 / Tape & Reel			

Notes: 7. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

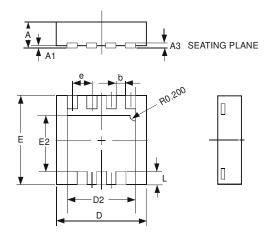
Marking Information



N45 = Product Type Marking Code YYWW = Date Code Marking YY = Last digit of year, ex: 09 for 2009 WW = Week code 01 to 52

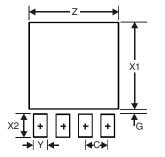


Package Outline Dimensions



DFN3030-8					
Dim	Min	Max	Тур		
Α	0.57	0.63	0.60		
A1	0	0.05	0.02		
A3		_	0.15		
b	0.29	0.39	0.34		
D	2.90	3.10	3.00		
D2	2.19	2.39	2.29		
e		_	0.65		
Е	2.90	3.10	3.00		
E2	1.64	1.84	1.74		
L	0.30	0.60	0.45		
All Dimensions in mm					

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.59
G	0.11
X1	2.49
X2	0.65
Y	0.39
С	0.65



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